24V Input, 500mA Buck Regulator with Dual-Input Power MUX

General Description

The MAX77756 is a synchronous 500mA step-down DC-DC converter with integrated dual-input power multiplexer (MUX). The converter operates on an input supply as low as 3.0V and as high as 24V. Default output voltage is factory-programmed to either 1.8V, 3.3V, or 5.0V. Output voltage is further adjustable through external resistors or an I^2C serial interface.

The dual-input power MUX selects the higher voltage from two different input sources to power the step-down converter. Control circuitry ensures that only one channel of the MUX is on at a time to prevent cross-conduction between input sources. For single-input applications, the MUX can be bypassed and the step-down converter can be powered directly from the SUP pin.

The MAX77756 is available in a small 2.33mm x 1.42mm (0.7mm max height), 15-bump wafer-level package (WLP). For a similar buck converter without a power MUX, refer to the MAX77596.

Applications

- USB Type-C Power Delivery Accessories and Devices
- Notebook and Tablet Computers
- Home Automation, Low IQ Smart Hubs
- Battery-Powered Systems, Backup Battery, Uninterruptible Rails

Ordering Information appears at end of data sheet.

Simplified Block Diagram

Benefits and Features

- Wide Input Power Supply
 - 3V to 24V Supply Voltage
 - 500mA (max) Output Current
 - 1.8V, 3.3V, or 5.0V Factory-Set V_{OUT} with Optional I²C Control: 1.5V to 7.5V in 50mV Steps
 - External Feedback Resistor V_{OUT} Option (1V to 99% V_{SUP})
 - · Hardware or Software Enable
- Dual-Input Power MUX Replaces Common-Cathode
 Diode Arrays
 - Automatic Ideal-Diode ORing Voltage Selector
 - 250m Ω MOSFETs Minimize Power Consumption, BOM, and Solution Size
- Low I_Q Enables Always-On Rails
 - 1.5µA Quiescent Current (Only SUP Powered)
 - 19µA Quiescent Current (IN1/IN2 Powered)
 - 88% Peak Efficiency (12V_{SUP}, 3.3V_{OUT})
- Safe and Easy to Use
 - Short-Circuit Hiccup Mode and Thermal Protection
 - 8ms Soft-Start
 - Software-Enabled Spread Spectrum
 - Pin-Programmable Inductor Peak Current Level
- Small Size
 - 2.33mm x 1.42mm (0.7mm max height) Wafer-Level Package (WLP)
 - 15-Bump, 0.4mm Pitch, 3 x 5 Array





24V Input, 500mA Buck Regulator with Dual-Input Power MUX

Absolute Maximum Ratings

IN1, IN2, SUP to PGND	0.3V to +26V
BIAS to PGND	0.3V to +6V
EN to PGND	0.3V to V _{SUP} + 0.3V
BST to LX	+6V
BST to PGND	0.3V to +31V
OUT/FB to PGND	0.3V to +12V
POK, ILIM to PGND	0.3V to V _{BIAS} + 0.3V
POK, SDA Sink Current	20mA
VIO to PGND	0.3V to +6V
SDA, SCL to PGND	0.3V to V _{IO} + 0.3V
AGND to PGND	-0.3V to +0.3V

IN1, IN2 Repetitive Forward Current (T _A = +85°C)	
10% Duty Square Wave	4.1A
IN1, IN2 SUP Continuous Current	1.6A _{RMS}
LX Continuous Current (Note 1)	1.6A _{RMS}
OUT/FB Short-Circuit Duration	Continuous
Continuous Power Dissipation (T _A = +70°C)	
(derate 16.22mW/°C above +70°C)	1298mW
Operating Temperature Range40)°C to +85°C
Junction Temperature	+150°C
Soldering Temperature (reflow)	+260°C

Note 1: LX has internal clamp diodes to PGND and SUP. Applications that forward bias these diodes should not exceed the IC's package power dissipation limits.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Package Information 15 WLP

Package Code	W151G2+1			
Outline Number	<u>21-100111</u>			
Land Pattern Number	90-100052 (Refer to Application Note 1891)			
Thermal Resistance, Four-Layer Board:				
Junction to Ambient (θ_{JA})	61.65°C/W			

For the latest package outline information and land patterns (footprints), go to www.maximintegrated.com/packages. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

Package thermal resistances were obtained using the method described in JEDEC specification JESD51-7, using a four-layer board. For detailed information on package thermal considerations, refer to www.maximintegrated.com/thermal-tutorial.

24V Input, 500mA Buck Regulator with Dual-Input Power MUX

Electrical Characteristics

 $(V_{SUP} = V_{EN} = 12V, V_{IO} = 1.8V, V_{IN1} = V_{IN2} = 0V$, configuration registers in reset. Limits are 100% production tested at $T_A = +25^{\circ}C$, limits over $T_A = -40^{\circ}C$ to +85°C are guaranteed by design and characterization, unless otherwise noted.)

PARAMETER	SYMBOL	С	MIN	TYP	MAX	UNITS	
STEP-DOWN CONVERTER	2						
SUP Voltage Range	V _{SUP}			3		24	V
SUP Undervoltage Lockout	V _{UVLO}	V _{SUP} rising	2.75	2.9	3.0	V	
SUP Undervoltage Lockout Hysteresis				300		mV	
SUP Shutdown Current	I _{SUP-SHDN}	V _{EN} = 0V (buck	converter disabled)		0.75	3.0	μA
SUP QUIESCENT CURREN	Т						
		I _{LOAD} = 0mA, V	/ _{OUT} = 1.8V		6	18	
SLIP Quiescent Current	lava a	I _{LOAD} = 0mA, V	/ _{OUT} = 3.3V		1.5	3.0	
	'SUP-Q	I _{LOAD} = 0mA, V	/ _{OUT} = 5.0V		2.65	5.0	μΑ
		I _{LOAD} = 0mA, e	xternal feedback version		32	70	
BIAS Regulator Voltage	V _{BIAS}	$V_{SUP} = 5.5V$ to connected to O		5		V	
Output Voltage Regulation Range	Vout-reg	Internal feedbac voltage, adjusta to 7.5V in 50mV V_OUTREG[7:0	1.5		7.5	V	
OUTPUT VOLTAGE ACCUR	RACY						
		V _{OUT-REG} = 1.8V, 1.8V factory-default version	V _{SUP} = 12V, I _{OUT} = 250mA, T _A = +25°C	1.78	1.8	1.82	
			V_{SUP} = 4.5V to 24V, I _{OUT} = 0mA to 500mA, T _A = -40°C to +85°C	1.746	1.8	1.854	
		V _{OUT-REG} = 3.3V, 3.3V	V_{SUP} = 12V, I_{OUT} = 250mA, T_A = +25°C	3.27	3.3	3.33	
OUT Voltage Accuracy	Vout	factory-default version	$V_{SUP} = 4.5V \text{ to } 24V,$ $I_{OUT} = 0\text{mA to } 500\text{mA},$ $T_A = -40^{\circ}\text{C} \text{ to } +85^{\circ}\text{C}$	3.2	3.3	3.4	
		Vout-REG	V_{SUP} = 12V, I_{OUT} = 250mA, T_A = +25°C	4.95	5	5.05	
		factory-default version	V _{SUP} = 6V to 24V, I _{OUT} = 0mA to 500mA, T _A = -40°C to +85°C	4.85	5	5.15	

24V Input, 500mA Buck Regulator with Dual-Input Power MUX

Electrical Characteristics (continued)

 $(V_{SUP} = V_{EN} = 12V, V_{IO} = 1.8V, V_{IN1} = V_{IN2} = 0V$, configuration registers in reset. Limits are 100% production tested at T_A = +25°C, limits over T_A = -40°C to +85°C are guaranteed by design and characterization, unless otherwise noted.)

PARAMETER	SYMBOL	CC	MIN	TYP	MAX	UNITS		
FB VOLTAGE ACCURACY								
	V	External	V_{SUP} = 12V, I_{LOAD} = 250mA, T_A = +25°C	0.99	1	1.01		
	VFB	version	$V_{SUP} = 3.0V \text{ to } 24V,$ $I_{LOAD} = 0\text{mA to } 500\text{mA},$ $T_{A} = -40^{\circ}\text{C} \text{ to } +85^{\circ}\text{C}$	0.97	1	1.03	v	
FB Input Current	I _{FB}	V _{FB} = 1V, extern	al feedback version		0.02		μA	
OUT/FB Wake-Up Threshold	V _{WAKE}	Standby mode ex I _{LOAD} = 0mA, ex percentage of V _C	xit threshold, pressed as a DUT-REG		99		%	
OUT/FB Load Regulation		0 to 300mA load,	FPWM mode (Note 2)		1		%	
OUT/FB Line Regulation		V _{SUP} = 4.5V to 2 FPWM mode (No	24V, V _{OUT} = 3.3V, ote 2)		0.02		%/V _{SUP}	
OUT/FB Soft-Start Ramp	t	SOFT_ST = 1			4			
Time	LSS	SOFT_ST = 0	SOFT_ST = 0				ms	
High-Side MOSFET On-Resistance	R _{ON-HS}	V _{BIAS} = 5V, I _{LX} =		500	800	mΩ		
Low-Side MOSFET On-Resistance	R _{ON-LS}	V _{BIAS} = 5V, I _{LX} =		500	800	mΩ		
		I_PEAK[1:0] = 0b00			700			
High-Side MOSFET Peak	I _{LX-PEAK}	I_PEAK[1:0] = 0		800		- mA		
Current Limit		I_PEAK[1:0] = 0	800	900	1000			
		I_PEAK[1:0] = 0k		1000				
Low-Side MOSFET Valley Current Threshold	ILX-VALLEY	Output overloade _{REG}), threshold I on-times are allo	ed (V _{OUT} < 25% of V _{OUT} - below where wed to start		500		mA	
High-Side MOSFET Minimum Current Threshold	I _{LX-PK-MIN}	Inductor current ramps to at least I _{LX-PK-MIN} while skipping			200		mA	
Low-Side MOSFET Zero-Crossing Threshold	I _{ZX}				40		mA	
Minimum On-Time (Note 3)	ton-min	V _{OUT} = 3.3V			80		ns	
Maximum Duty Cycle	D _{MAX}				99		%	
Switching Frequency	f _{SW}	Continuous cond	luction	0.94	1	1.06	MHz	
Spread-Spectrum Frequency Range	Δf_{SW}	Spread-spectrum	n enabled		±6		%	

24V Input, 500mA Buck Regulator with Dual-Input Power MUX

Electrical Characteristics (continued)

 $(V_{SUP} = V_{EN} = 12V, V_{IO} = 1.8V, V_{IN1} = V_{IN2} = 0V$, configuration registers in reset. Limits are 100% production tested at $T_A = +25^{\circ}C$, limits over $T_A = -40^{\circ}C$ to +85°C are guaranteed by design and characterization, unless otherwise noted.)

PARAMETER	SYMBOL	С	ONDITIONS	MIN	TYP	MAX	UNITS		
Soft-Short Output Voltage Monitor Threshold	V _{OUT-OVRLD}				0.25 x V _{OUT-REG}	6	V		
Output-Overloaded Retry Timer	^t RETRY	Switching stopp V _{OUT} < 25% of consecutive swi current limit, tim attempts to soft		15		ms			
POWER MULTIPLEXER									
IN1/IN2 Minimum Initial Operating Voltage	V _{IN1} /V _{IN2}	Minimum initial power MUX FE ⁻ activate selection		V _{UVLO} + 0.7		V			
IN1/IN2 QUIESCENT CURF	RENT								
		V _{OUT} = 1.8V, V I _{LOAD} = 0mA	_{IN1} or V _{IN2} = 12V,		38	100			
IN1/IN2 Outcocont Ourront	I _{IN1-Q} /I _{IN2-Q}	V _{OUT} = 3.3V, V I _{LOAD} = 0mA		18.5	30				
in miz quescent current		$V_{OUT} = 5.0V, V$ $I_{LOAD} = 0mA$		25	40	μΛ			
		V _{IN1} or V _{IN2} = 7 external feedba		42	100				
IN1/IN2 to SUP On-Resis-	R _{ON-IN1}	V _{IN1} = 5.5V, I _{IN}	V _{IN1} = 5.5V, I _{IN1} = 90mA			400	m0		
tance	R _{ON-IN2}	V _{IN2} = 5.5V, I _{IN}		250	400	11122			
	I _{IN1-LEAK}	$V_{SUP} = 12V,$ $V_{IN1} = V_{IN2} = 0V/1011/1012$ to	Current from IN1		0.003	1			
IN I/INZ LEAKAYE	I _{IN2-LEAK}	UV, IN1/IN2 to SUP channel is off	SUP channel is off	SUP channel is off	Current from IN2		0.003	1	μΑ
Channel Selection Hysteresis		(Note 4)			400		mV		
POWER-OK OUTPUT (POP	<)								
DOK Threshold	VPOK-RISING	V _{OUT} rising, expressed as a percentage of V _{OUT-REG} V _{OUT} falling, expressed as a percentage of V _{OUT-REG}		90	92	94	0/		
	VPOK-FALLING			88	90	92	70		
POK Debounce Timer	tPOK-DB				12		μs		
POK Leakage Current	IPOK	POK = high (hig T _A = +25°C	jh impedance),			1	μA		
POK Low Voltage	V _{POK}	POK = low, sink	ing 1mA			0.4	V		

24V Input, 500mA Buck Regulator with Dual-Input Power MUX

Electrical Characteristics (continued)

 $(V_{SUP} = V_{EN} = 12V, V_{IO} = 1.8V, V_{IN1} = V_{IN2} = 0V$, configuration registers in reset. Limits are 100% production tested at T_A = +25°C, limits over T_A = -40°C to +85°C are guaranteed by design and characterization, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS	MIN	ТҮР	MAX	UNITS
ENABLE INPUT (EN)						
EN Logic-High Threshold	V _{EN_HI}		1.4			V
EN Logic-Low Threshold	V _{EN_LO}				0.4	V
EN Leakage Current	I _{EN}	V _{EN} = V _{SUP} = 12V		0.1		μA
HIGH-SIDE CURRENT LIMI	IT INPUT (ILIM)					
ILIM Logic-High Threshold	V _{ILIM_HI}		1.4			V
ILIM Logic-Low Threshold	VILIM_LO				0.4	V
SERIAL INTERFACE/I/O ST	AGE					
V _{IO} Voltage Range	V _{IO}		1.7		5.5	V
V _{IO} Valid Logic Threshold			1.7			V
V _{IO} Bias Current		T _A = +25°C	-1	0	+1	μA
SCL, SDA Input High Voltage	V _{IH}		0.7 x V _{IO}			V
SCL, SDA Input Low Voltage	V _{IL}				0.3 x V _{IO}	V
SCL, SDA Input Hysteresis	V _{HYS}			0.05 x V _{IO}		V
SCL, SDA Input Leakage Current	lı	V_{IO} = 5.5V, V_{SCL} = V_{SDA} = 0V or 5.5V	-10		+10	μA
SDA Output Low Voltage	V _{OL}	Sinking 20mA			0.4	V
SCL, SDA Pin Capacitance		(Note 5)		10		pF
Input Filter Suppressed Spike Maximum Pulse Width	t _{SP}	(Note 5)		50		ns
SERIAL INTERFACE/TIMIN	G					
Clock Frequency	f _{SCL}				1	MHz
Bus Free Time Between STOP and START Condition	^t BUF		0.5			μs
Setup Time REPEATED START Condition	^t SU;STA		260			ns
Hold Time REPEATED	^t HD;STA		260			ns

24V Input, 500mA Buck Regulator with Dual-Input Power MUX

Electrical Characteristics (continued)

 $(V_{SUP} = V_{EN} = 12V, V_{IO} = 1.8V, V_{IN1} = V_{IN2} = 0V$, configuration registers in reset. Limits are 100% production tested at T_A = +25°C, limits over T_A = -40°C to +85°C are guaranteed by design and characterization, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS		
SCL Low Period	^t LOW		500			ns		
SCL High Period	thigh		260			ns		
Data Setup Time	^t SU;DAT		50			ns		
Data Hold Time	^t HD;DAT		0			μs		
SDA Fall Time	t _F	Time measured between V_{IO} and V_{OL} (Note 5)			120	ns		
Setup Time for STOP Condition	^t su;sto		260			ns		
THERMAL PROTECTION								
Thermal Shutdown	T _{SHDN}	Junction temperature rising		+165		°C		
Thermal Shutdown Hysteresis				+15		°C		

Note 1: See the BIAS Regulator section.

Note 2: Forced PWM (FPWM) is an internal test mode.

Note 3: Output voltage regulation is always maintained. The device skips pulses when the duty cycle needed to regulate the output violates the minimum on-time.

Note 4: Off channel must be half of this value higher than the on channel for switch to happen.

Note 5: Design guidance only. Not production tested.

24V Input, 500mA Buck Regulator with Dual-Input Power MUX

Typical Operating Characteristics

($V_{INx} = V_{EN} = 12V$, $T_A = +25^{\circ}C$, internal feedback version, unless otherwise noted.)



24V Input, 500mA Buck Regulator with Dual-Input Power MUX

Typical Operating Characteristics (continued)

(V_{INx} = V_{EN} = 12V, T_A = +25°C, internal feedback version, unless otherwise noted.)



24V Input, 500mA Buck Regulator with Dual-Input Power MUX

Typical Operating Characteristics (continued)

(V_{INx} = V_{EN} = 12V, T_A = +25°C, internal feedback version, unless otherwise noted.)





24V Input, 500mA Buck Regulator with Dual-Input Power MUX

Typical Operating Characteristics (continued)

 $(V_{INx} = V_{EN} = 12V, T_A = +25^{\circ}C$, internal feedback version, unless otherwise noted.)





24V Input, 500mA Buck Regulator with Dual-Input Power MUX

Typical Operating Characteristics (continued)

 $(V_{INx} = V_{EN} = 12V, T_A = +25^{\circ}C$, internal feedback version, unless otherwise noted.)













24V Input, 500mA Buck Regulator with Dual-Input Power MUX

Bump Configuration



Bump Description

BUMP	NAME	FUNCTION
A1	IN1	Power MUX Input 1. IN1 and IN2 have equal priority to the power selector. Selection logic is only active when the IC is enabled through the EN pin or EN_BIT. A diode always exists between IN1 and SUP. Connect to PGND to force PFET between IN1 and SUP off.
C1	IN2	Power MUX Input 2. IN1 and IN2 have equal priority to the power selector. Selection logic is only active when the IC is enabled through the EN pin or EN_BIT. A diode always exists between IN2 and SUP. Connect to PGND to force PFET between IN2 and SUP off.
A3	BST	High-Side FET Driver Supply. Connect a 0.1µF ceramic capacitor between BST and LX.
A2	SUP	Power MUX Output and Buck Supply Input. Bypass with a 1μ F ceramic capacitor to PGND as close as possible to the IC. If using IN1/IN2 to power the IC, do not prebias the SUP capacitor or connect SUP to external loads. If using SUP to power the IC, connect IN1 and IN2 to PGND.
A4	LX	Switching Node. LX is high impedance when the converter is disabled.
A5	PGND	Power Ground. Connect to AGND on the PCB. Return the SUP and OUT bypass capacitors to PGND.
B4	AGND	Quiet Ground. Connect to PGND on the PCB. Return the BIAS bypass capacitor to AGND.
C5	POK	Open-Drain Power OK Output. An external pullup resistor is required.
C3	BIAS	Low-Voltage Internal IC Supply. Bypass to AGND with a 1µF ceramic capacitor. Do not load this pin externally.
В5	OUT/FB	Internal Feedback Versions (MAX77756A/B/C) : Output Voltage Sense Input. Connect a 10µH inductor between OUT and LX. Bypass OUT to PGND with a minimum 22µF ceramic capacitor. External Feedback Version (MAX77756D) : Feedback Input. Connect a resistor voltage divider between the converter's output and AGND to set the output voltage. Connect a 5.6pF feed-forward capacitor between the converter's output and FB. Do not route FB close to sources of EMI or noise.

24V Input, 500mA Buck Regulator with Dual-Input Power MUX

Bump Description (continued)

BUMP	NAME	FUNCTION
В3	EN	Enable Input. Enables both the step-down converter and the power MUX. EN is compatible with the SUP voltage domain. Drive EN to PGND to disable the device. Drive EN above V_{EN_HI} to enable the device. If using I ² C to control the buck, the enable bit (EN_BIT) interacts with the EN pin. See the <i>Enable Control</i> section.
B1	V _{IO}	I ² C Serial Interface Voltage Supply. Connect to PGND if not used.
C2	SCL	I ² C Serial Interface Clock. This pin requires a pullup resistor to V _{IO} . Connect to PGND if not used.
B2	SDA	I ² C Serial Interface Data. This pin requires a pullup resistor to V _{IO} . Connect to PGND if not used.
C4	ILIM	LX Peak Current Limit Setting Input. Connect to PGND to set $I_{LX-PEAK}$ to 700mA. Connect to BIAS to set $I_{LX-PEAK}$ to 1000mA. I ² C writes to control $I_{LX-PEAK}$ are only accepted while ILIM is logic-low. See the <i>Peak Inductor Current Limit (ILIM)</i> section for details.

Functional Diagram



24V Input, 500mA Buck Regulator with Dual-Input Power MUX

Detailed Description

The MAX77756 is a small 500mA step-down DC-DC converter with integrated dual-input power multiplexer (MUX). The step-down (buck) converter uses synchronous rectification and internal current-mode compensation. The buck operates on a supply voltage from 3V to 24V. Output voltage is configurable through I²C (1.5V to 7.5V in 50mV steps) or external feedback resistors (1V to 99% of V_{SUP}). Factory-default voltage options of 1.8V, 3.3V, and 5.0V are available (see the <u>Ordering Information</u> table). Switching frequency in continuous conduction is 1MHz. The buck utilizes an ultra-low quiescent current mode (1.5µA typ for 3.3V_{OUT}) that maintains a very high efficiency at light loads.

The integrated dual-input power MUX automatically selects the higher of two different voltage sources to power the buck converter. The MUX reduces power dissipation versus common-cathode Schottky arrays by using switches (MOSFETs) instead of diodes. The output of the power MUX is the input to the buck (SUP). Single power source applications should bypass the power MUX and power SUP directly.

Dual-Input Power MUX

The device integrates a 24V power multiplexer (MUX) with two inputs (IN1 and IN2) and one output (SUP). SUP is the supply input for the buck. The input channels consist of P-type MOSFETs. IN1 and IN2 are the individual FET drains and SUP is the common FET source. An intrinsic body-diode is always present in both FETs.

The MUX connects the higher of V_{IN1} or V_{IN2} to SUP to power the buck. Only the higher voltage input channel is on. The lower voltage input channel is off. The MUX logic is only active while the buck converter is enabled. Both channels are off when the buck is disabled.

The selection logic has switchover hysteresis to avoid chattering. The off channel must be 200mV higher than the on channel to cause a switchover. Switchover is automatic and can happen any time while the buck is enabled. Equal priority is given to each input. Neither channel is prioritized over the other.

When powering IN1 or IN2, do not connect anything to SUP besides a decoupling capacitor. To use the buck without the power MUX, connect IN1 and IN2 to PGND and power SUP directly.

Buck Regulator Control Scheme

The step-down converter uses a PWM peak current-mode control scheme with a load-line architecture. Peak current-mode control provides precise control of the inductor current on a cycle-by-cycle basis and inherent compensation for input voltage variation.

On-times (MOSFET Q1 on) are started by a fixedfrequency clock and terminated by a PWM comparator. See Figure 1. When an on-time ends (starting an off-time) current conducts through the low-side MOSFET (Q2 on). Shoot-through current from SUP to PGND is avoided by introducing a brief period of dead time between switching events when neither MOSFET is on. Inductor current conducts through Q2's intrinsic body diode during dead time.

The PWM comparator regulates V_{OUT} by controlling duty cycle. The negative input of the PWM comparator is a voltage proportional to the actual output voltage error. The positive input is the sum of the current-sense signal through MOSFET Q1 and a slope-compensation ramp. The PWM comparator ends an on-time when the error voltage becomes less than the slope-compensated current-sense signal. On-times begin again due to a fixedfrequency clock pulse. The controller's compensation components and current-sense circuits are integrated. This reduces the risk of routing sensitive control signals on the PCB.

A load-line architecture is present in the controller design. The output voltage is positioned slightly above nominal regulation at no load and slightly below nominal regulation at full load. As the output load changes, a small but controlled amount of load regulation (load line) error occurs on the output voltage. This voltage positioning architecture allows the output voltage to respond to sudden load transients in a critically damped manner, and effectively reduces the amount of output capacitance needed when compared to classical integrating controllers. See the *Typical Operating Characteristics* section for information about the converter's typical voltage regulation behavior versus load.

24V Input, 500mA Buck Regulator with Dual-Input Power MUX

Figure 1. Buck Control Scheme Diagram

SKIP Mode Operation

The buck converter permanently operates in SKIP mode with the added ability to transition into a lower power mode called standby. SKIP mode causes discontinuous inductor current at light loads by forcing the low-side MOSFET (Q2) off if inductor current falls below I_{ZX} (40mA typ) during an off-time. This prevents inductor current from sourcing back to the input (SUP) and enables high efficiency by reducing the total number of switching cycles required to regulate the output voltage.

If the output voltage is within regulation and the load is very light then the converter automatically transitions to standby mode. In this mode, the LX node is high impedance and the converter's internal circuit blocks are deactivated to reduce I_Q consumption. A single, low-power comparator remains on to monitor the output voltage during standby. When V_{OUT} drops below V_{WAKE} (99% of V_{OUT-REG} typ), the converter reactivates and starts switching again.

Enable Control

Raise the EN pin voltage above V_{EN_HI} (or tie to SUP) to enable the IC. To disable, bring EN pin voltage to PGND.

When using I²C to control the MAX77756, the EN pin interacts with the enable bit (EN_BIT). The logical relationship between the EN pin and EN_BIT is by default an OR. The EN_CTRL bit can be used to switch this relationship to a logical AND. See Table 1.

The reset state (default state) of EN_BIT and EN_CTRL is 0. This means that the default relationship between EN pin and EN_BIT is a logical OR.

EN CTRL REGULATOR EN BIT EN (PIN) OUTPUT (BIT) (BIT) 0 0 OFF 0 1 ON 0 (logical OR) 1 0 ON 1 1 ON 0 0 OFF 1 0 1 OFF (logical 0 1 OFF AND) 1 1 ON

Table 1. Enable Control Truth Table

BIAS Regulator

An integrated 5V (V_{BIAS}) linear regulator provides power to internal circuit blocks. This regulator is used during startup for all versions of the MAX77756. For internal feedback versions (no external programming resistors) where V_{OUT-REG} is programmed between (and including) 3.3V and 5.0V, the BIAS regulator is deactivated and the BIAS node is internally connected to OUT after the output voltage is within regulation. Switching BIAS to OUT utilizes the buck converter's efficiency to power its own internal circuit blocks (as opposed to a linear regulator) and improves the IC's power efficiency. For the external feedback version of the MAX77756, the BIAS regulator is permanently active. Do not load BIAS externally for any MAX77756 version.

The BIAS regulator is on whenever the EN pin is high or V_{IO} voltage is valid (regardless of whether the buck regulator is on or off). Connect a $1\mu F$ ceramic capacitor from BIAS and GND.

Soft-Start

The device has an internal soft-start timer (t_{SS}) that controls the ramp time of V_{OUT} as the converter is starting. The soft-start feature limits inrush current during startup. SOFT_ST programs t_{SS} to 8ms or 4ms. The default value is 8ms. The converter soft-starts every time the IC is enabled, exits a UVLO condition, and/or retries from an overcurrent or overtemperature condition.

Power-OK (POK) Output

The device features an open-drain POK output to monitor the output voltage. POK requires an external pullup resistor. POK goes high (high-impedance) after the regulator output increases above 92% ($V_{POK-RISING}$) of the nominal regulated voltage ($V_{OUT-REG}$). POK goes low when the regulator output drops to below 90% ($V_{POK-FALLING}$) of $V_{OUT-REG}$.

Peak Inductor Current Limit (ILIM)

The buck converter's high-side MOSFET peak current limit ($I_{LX-PEAK}$) is register or pin programmable. Applications can use $I_{LX-PEAK}$ programmability to ensure that the converter never exceeds the saturation current rating of the inductor on the PCB.

Connect ILIM to PGND to set $I_{LX-PEAK}$ to 700mA. While ILIM is logic-low, the bits in I_PEAK[1:0] can be changed through I²C to program $I_{LX-PEAK}$ from 700mA to 1000mA in 100mA steps. The value of $I_{LX-PEAK}$ returns to 700mA (I_PEAK[1:0] = 0b00) if the configuration registers reset.

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Connect ILIM to a voltage above V_{ILIM} H to program I_{LX} PEAK to 1000mA. While ILIM is high, I_{LX} PEAK is fixed at 1000mA and the I_PEAK[1:0] bitfield is ignored.

Short-Circiut Hiccup Mode and Thermal Protection

The device has fault protection designed to protect itself from abnormal conditions. If the output is overloaded, cycle-by-cycle current limit prevents inductor current from increasing beyond $I_{LX-PEAK}$.

The buck stops switching if V_{OUT} falls to less than 25% of programmed V_{OUT-REG} and 15 consecutive on-times are ended by current limit. After switching stops, the buck waits for t_{RETRY} (15ms typ) before attempting to soft-start again (hiccup mode). While V_{OUT} is less than 25% of target, the converter prevents new on-times if the inductor current has not fallen below I_{LX-VALLEY} (500mA typ). This prevents inductor current from increasing uncontrollably due to the short-circuited output.

Spread-Spectrum Option

Enable spread-spectrum operation by setting the S_ SPECT bit to 1. When enabled, the switching frequency is varied $\pm 6\%$ centered on 1MHz. The modulation signal is a triangle wave with a period of 256µs.

Register Reset Condition

The device's internal configuration registers reset to their default values if V_{SUP} falls below the UVLO falling threshold (V_{SUP-UVLO} minus UVLO hysteresis, 2.6V typ) or if the voltage on the V_{IO} pin becomes invalid (< 1.7V). Connect V_{IO} to PGND to ensure that configuration registers remain in factory-configured reset. Contact the factory to request a version of the IC that does not reset registers when V_{IO} becomes invalid.

Serial Interface

Overview

The MAX77756 features a revision 3.0 l²C-compatible, 2-wire serial interface consisting of a bidirectional serial data line (SDA) and a serial clock line (SCL). The MAX77756 acts as a slave-only devices where it relies on the master to generate a clock signal. SCL clock rates from 0Hz to 3.4MHz are supported. l²C is an opendrain bus, and therefore, SDA and SCL require pullups. Optional resistors (24 Ω) in series with SDA and SCL protect the device inputs from high-voltage spikes on the bus lines. Series resistors also minimize crosstalk and undershoot on bus signals. For additional information on l²C, refer the l²C bus specification and users manual UM10204 that is readily available and free on the internet.

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Features

- I²C Revision 3-compatible serial communications channel
- 0Hz to 100kHz (standard mode)
- 0Hz to 400kHz (fast mode)
- 0Hz to 1MHz (fast mode plus)
- 0Hz to 3.4MHz (high-speed mode)
- Does not utilize I²C clock stretching

I²C System Configuration

The I²C bus is a multimaster bus. The maximum number of devices that can attach to the bus is only limited by bus capacitance.

A device on the I²C bus that sends data to the bus in called a transmitter. A device that receives data from the bus is called a receiver. The device that initiates a data transfer and generates the SCL clock signals to control the data transfer is a master. Any device that is being addressed by the master is considered a slave. The MAX77756 I²C-compatible interface operates as a slave on the I²C bus with transmit and receive capabilities.

I²C Interface Power

The IC's I²C interface derives its power from V_{IO}. Typically, a power input such as V_{IO} requires a local 0.1μ F ceramic bypass capacitor to ground. However, in highly-integrated power distribution systems, a dedicated capacitor might not be necessary. If the impedance

between V_{IO} and the next closest capacitor ($\ge 0.1\mu$ F) is less than 100m Ω in series with 10nH, then a local capacitor is not needed. Otherwise, bypass V_{IO} to PGND with a 0.1µF ceramic capacitor.

 V_{IO} accepts voltages from 1.7V to 5.5V. Cycling V_{IO} resets the I^2C registers.

I²C Data Transfer

One data bit is transferred during each SCL clock cycle. The data on SDA must remain stable during the high period of the SCL clock pulse. Changes in SDA while SCL is high are control signals. See the <u>I²C Start and Stop</u> <u>Conditions</u> section. Each transmit sequence is framed by a START (S) condition and a STOP (P) condition. Each data packet is nine bits long: eight bits of data followed by the acknowledge bit. Data is transferred with the MSB first.

I²C Start and Stop Conditions

When the serial interface is inactive, SDA and SCL idle high. A master device initiates communication by issuing a START condition. A START condition is a high-to-low transition on SDA with SCL high. A STOP condition is a low-to-high transition on SDA, while SCL is high. See Figure 3.

A START condition from the master signals the beginning of a transmission to the MAX77756. The master terminates transmission by issuing a not acknowledge (nA) followed by a STOP condition. See the <u>I2C Acknowledge</u> *Bit* section for information on not acknowledge. The STOP

Figure 2. I²C System Configuration

Figure 3. I²C Start and Stop Conditions

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condition frees the bus. To issue a series of commands to the slave, the master can issue repeated start (Sr) commands instead of a STOP command to maintain control of the bus. In general, a repeated start command is functionally equivalent to a regular start command.

When a STOP condition or incorrect address is detected, the IC disconnects SCL from the serial interface until the next START condition, minimizing digital noise and feedthrough.

I²C Acknowledge Bit

Both the I²C bus master and the MAX77756 (slave) generate acknowledge bits when receiving data. The acknowledge bit is the last bit of each nine bit data packet. To generate an acknowledge (A), the receiving device must pull SDA low before the rising edge of the acknowledge-related clock pulse (ninth pulse) and keep it low during the high period of the clock pulse. See Figure 4. To generate a not acknowledge (nA), the receiving device allows SDA to be pulled high before the rising edge of the acknowledge-related clock pulse and leaves it high during the high period of the clock pulse.

Monitoring the acknowledge bits allows for detection of unsuccessful data transfers. An unsuccessful data transfer occurs if a receiving device is busy or if a system fault has occurred. In the event of an unsuccessful data transfer, the bus master should reattempt communication at a later time.

The MAX77756 issues an ACK for all register addresses in the possible address space even if the particular register does not exist.

I²C Slave Address

The I²C controller implements 7-bit slave addressing in Table 2. An I²C bus master initiates communication with the slave by issuing a START condition followed by the slave address. See Figure 5.

I²C Clock Stretching

In general, the clock signal generation for the I²C bus is the responsibility of the master device. The I²C specification allows slow slave devices to alter the clock signal by holding down the clock line. The process in which a slave device holds down the clock line is typically called clock stretching. The IC does not use any form of clock stretching to hold down the clock line.

Figure 4. Acknowledge Bit

Table 2. I²C Slave Address Options

7-BIT SLAVE ADDRESS	8-BIT WRITE ADDRESS	8-BIT READ ADDRESS		
0x1E, 0b 001 1110	0x3C, 0b 0011 1100	0x3D, 0b 0011 1101		

Figure 5. Slave Address Example

I²C Communication Speed

The MAX77756 is compatible with all 4 communication speed ranges as defined by the Revision 3 I^2C specification:

- 0Hz to 100kHz (standard mode)
- 0Hz to 400kHz (fast mode)
- 0Hz to 1MHz (fast mode)
- 0Hz to 3.4MHz (high-speed mode)

Operating in standard mode, fast mode, and fast mode plus does not require any special protocols. The main consideration when changing the bus speed through this range is the combination of the bus capacitance and pullup resistors. Higher time constants created by the bus capacitance and pullup resistance (C x R) slow the bus operation. Therefore, when increasing bus speeds, the pullup resistance must be decreased to maintain a reasonable time constant. Refer to the Pullup Resistor Sizing section of the I²C Revision 3.0 specification (UM10204) for detailed guidance on the pullup resistor selection. In general for bus capacitances of 200pF, a 100kHz bus needs 5.6kΩ pullup resistors, a 400kHz bus needs about a 1.5k Ω pullup resistors, and a 1MHz bus needs 680 Ω pullup resistors. Note that when the open-drain bus is low, the pullup resistor is dissipating power, lower value pullup resistors dissipate more power.

Operating in high-speed mode requires some special considerations. The major considerations with respect to the IC:

• The I²C bus master use current source pullups to shorten the signal rise.

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- The I²C slave must use a different set of input filters on its SDA and SCL lines to accommodate for the faster bus.
- The communication protocols need to utilize the highspeed master code.

At power-up and after each stop condition, the IC input filters are set for standard mode, fast mode, or fast mode plus (i.e., 0Hz to 1MHz). To switch the input filters for high-speed mode, use the high-speed master code protocols that are described in the <u>I2C Communication Protocols</u> section.

I²C Communication Protocols

The IC supports both writing and reading from its registers.

Writing to a Single Register

<u>Figure 6</u> shows the protocol for the I^2C master device to write one byte of data to the MAX77756. This protocol is the same as the SMBus specification's write byte protocol. The write byte protocol is as follows:

- 1) The master sends a start command (S).
- 2) The master sends the 7-bit slave address followed by a write bit (R/W = 0).
- 3) The addressed slave asserts an acknowledge (A) by pulling SDA low.
- 4) The master sends an 8-bit register pointer.
- 5) The slave acknowledges the register pointer.
- 6) The master sends a data byte.
- 7) The slave updates with the new data.

Figure 6. Writing to a Single Register with the Write Byte Protocol

- 8) The slave acknowledges or does not acknowledge the data byte. The next rising edge on SDA loads the data byte into its target register and the data becomes active.
- 9) The master sends a stop condition (P) or a repeated start condition (Sr). Issuing a P ensures that the bus input filters are set for 1MHz or slower operation. Issuing an Sr leaves the bus input filters in their current state.

Writing Multiple Bytes to Sequential Registers

<u>Figure 7</u> shows the protocol for writing to a sequential registers. This protocol is similar to the write byte protocol above, except the master continues to write after it receives the first byte of data. When the master is done writing it issues a stop or repeated start. The writing to sequential registers protocol is as follows:

- 1) The master sends a start command (S).
- The master sends the 7-bit slave address followed by a write bit (R/W = 0).

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- The addressed slave asserts an acknowledge (A) by pulling SDA low.
- 4) The master sends an 8-bit register pointer.
- 5) The slave acknowledges the register pointer.
- 6) The master sends a data byte.
- 7) The slave acknowledges the data byte. The next rising edge on SDA loads the data byte into its target register and the data becomes active.
- 8) Steps 6 to 7 are repeated as many times as the master requires.
- 9) During the last acknowledge related clock pulse, the master can issue an acknowledge or a not acknowledge.
- 10) The master sends a stop condition (P) or a repeated start condition (Sr). Issuing a P ensures that the bus input filters are set for 1MHz or slower operation. Issuing an Sr leaves the bus input filters in their current state.

Figure 7. Writing to Sequential Registers X to N

Reading from a Single Register

<u>Figure 8</u> shows the protocol for the I²C master device to read one byte of data to the MAX77756. This protocol is the same as the SMBus specification's read byte protocol. The read byte protocol is as follows:

- 1) The master sends a start command (S).
- 2) The master sends the 7-bit slave address followed by a write bit (R/W = 0).
- 3) The addressed slave asserts an acknowledge (A) by pulling SDA low.
- 4) The master sends an 8-bit register pointer.
- 5) The slave acknowledges the register pointer.
- 6) The master sends a repeated start command (Sr).
- 7) The master sends the 7-bit slave address followed by a read bit (R/W = 1).
- 8) The addressed slave asserts an acknowledge by pulling SDA low.
- 9) The addressed slave places 8 bits of data on the bus from the location specified by the register pointer.

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- 10) The master issues a not acknowledge (nA).
- 11) The master sends a stop condition (P) or a repeated start condition (Sr). Issuing a P ensures that the bus input filters are set for 1MHz or slower operation. Issuing an Sr leaves the bus input filters in their current state.

Note that when the the IC receives a stop, it does not modify its register pointer.

Reading from Sequential Registers

<u>Figure 9</u> shows the protocol for reading from sequential registers. This protocol is similar to the read byte protocol except the master issues an acknowledge to signal the slave that it wants more data: when the master has all the data it requires it issues a not acknowledge (nA) and a stop (P) to end the transmission. The continuous read from sequential registers protocol is as follows:

- 1) The master sends a start command (S).
- The master sends the 7-bit slave address followed by a write bit (R/W = 0).
- The addressed slave asserts an acknowledge (A) by pulling SDA low.

Figure 8. Reading from a Single Register with the Read Byte Protocol

Figure 9. Reading Continuously from Sequential Registers X to N

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- 4) The master sends an 8-bit register pointer.
- 5) The slave acknowledges the register pointer.
- 6) The master sends a repeated start command (Sr).
- 7) The master sends the 7-bit slave address followed by a read bit (R/W = 1). When reading the RTC timekeeping registers, secondary buffers are loaded with the timekeeping register data during this operation.
- 8) The addressed slave asserts an acknowledge by pulling SDA low.
- 9) The addressed slave places 8 bits of data on the bus from the location specified by the register pointer.
- 10) The master issues an acknowledge (A) signaling the slave that it wishes to receive more data.
- 11) Steps 9 to 10 are repeated as many times as the master requires. Following the last byte of data, the master must issue a not acknowledge (nA) to signal that it wishes to stop receiving data.
- 12) The master sends a stop condition (P) or a repeated start condition (Sr). Issuing a stop (P) ensures that the bus input filters are set for 1MHz or slower operation. Issuing an Sr leaves the bus input filters in their current state.

Note that when the the IC receives a stop it does not modify its register pointer.

Engaging High-Speed (HS) Mode for Operation Up to 3.4MHz

<u>Figure 10</u> shows the protocol for engaging HS mode operation. HS mode operation allows for a bus operating speed up to 3.4MHz.The procedure to engage HS mode protocol is as follows:

- Begin the protocol while operating at a bus speed of 1MHz or lower.
- The master sends a start command (S).
- The master sends the 8-bit master code of 0b0000 1XXX where 0bXXX are don't care bits.
- The addressed slave issues a not acknowledge (nA).
- The master can now increase its bus speed up to 3.4MHz and issue any read/write operation.

The master can continue to issue high-speed read/write operations until a stop (P) is issued. Use repeated start (Sr) to continue operations in high speed mode.

Figure 10. Engaging HS Mode

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Register Map

MAX77756

ADDRESS	NAME	MSB							LSB
Configuration Registers									
0x00	CONFIG_A[7:0]	S_SPECT	SOFT_ST	I_PEA	K[1:0]	RSVD	RSVD	EN_CTRL	EN_BIT
0x01	CONFIG_B[7:0]	V_OUTREG[7:0]							

CONFIG_A (0x00)

BIT	7	6	5	4	3	2	1	0
Field	S_SPECT	SOFT_ST	I_PEAK[1:0]		RSVD	RSVD	EN_CTRL	EN_BIT
Reset	0	0	00		OTP	0	0	0
Access Type	Write, Read	Write, Read	Write,	Read	Read Only	Write, Read	Write, Read	Write, Read

BITFIELD	BITS	DESCRIPTION	DECODE
S_SPECT	7	Spread-spectrum modulation enable control.	0 = Spread-spectrum modulation off 1 = Spread-spectrum modulation on
SOFT_ST	6	Soft-start control. Sets the regulator's startup ramp time ($t_{\rm SS}$).	0 = 8ms 1 = 4ms
I_PEAK	5:4	High-side DMOS peak current limit threshold control. Sets peak LX current (I _{LX-PEAK}) only while the ILIM pin is low. See <u>Peak Inductor</u> <u>Current Limit (ILIM)</u> for details.	00 = 700mA 01 = 800mA 10 = 900mA 11 = 1000mA
RSVD	3	Factory-set control bit. Writes are ignored.	N/A
RSVD	2	Reserved control bit. Write to 0.	N/A
EN_CTRL	1	Enable logic control bit. Determines the logical relationship between the EN_BIT (enable bit) and EN (enable pin).	0 = Logical OR relationship 1 = Logical AND relationship
EN_BIT	0	Regulator enable bit.	0 = Disabled 1 = Enabled

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CONFIG_B (0x01)

BIT	7	6	5	4	3	2	1	0
Field	V_OUTREG[7:0]							
Reset	0x06 / 0x24 / 0x46 (See Ordering Information)							
Access Type	Write, Read							

BITFIELD	BITS	DESCRIPTION	DECODE
V_OUTREG	7:0	Output Voltage Control. Programmable in 50mV per LSB from 0x00 (1.5V) to 0x78 (7.5V). Restrict writes to this register between 0x00 and 0x78. Do not program this register with codes outside this range. This register is a don't care for the external feedback version (MAX77756D).	0x00 = 1.5V 0x01 = 1.55V 0x02 = 1.6V 0x24 = 3.3V 0x46 = 5.0V 0x78 = 7.5V

Applications Information

IN1/IN2/SUP Capacitor Selection

For dual-input applications, connect separate voltage supplies to IN1 and IN2 and bypass IN1 (C_{IN1}) and IN2 (C_{IN2}) to PGND with 2.2µF ceramic capacitors. Bypass SUP to PGND with a 1µF ceramic capacitor (C_{SUP}). The C_{SUP} capacitor adds with the C_{IN1}/C_{IN2} capacitor to decouple the input of the buck. Larger values of C_{SUP} improve decoupling, but increase inrush current from IN1 or IN2 to SUP when a power source is connected. Limit IN1/IN2 inrush current to 4.1A. See the <u>Absolute</u> <u>Maximum Ratings</u> section for more information.

For single input applications that do not utilize IN1 and IN2, choose C_{SUP} to be a 2.2µF nominal capacitor that maintains a 1µF effective capacitance at its working voltage. Larger values improve the decoupling for the buck regulator, but increase inrush current from the voltage supply when connected. Connect IN1 and IN2 to PGND to force the power MUX selection logic off for applications that require no selector.

 C_{IN1}/C_{IN2} plus C_{SUP} reduces the current peaks drawn from the input power source during buck operation and reduces switching noise in the system. The ESR/ESL of C_{SUP} and its series PCB traces should be very low (i.e., < 15m Ω + < 2nH) for frequencies up to 2MHz. Ceramic capacitors with X5R or X7R dielectric are highly recommended due to their small size, low ESR, and small temperature coefficients.

Choose the $C_{IN1}/C_{IN2}/C_{SUP}$ capacitor voltage rating to be greater than the expected input voltage of the system. For systems using the full input voltage range (24V max) of the MAX77756, choose capacitors rated to 25V or greater.

All ceramic capacitors derate with DC bias voltage (effective capacitance goes down as DC bias goes up). Generally, small case size capacitors derate heavily compared to larger case sizes (0603 case size performs better than 0402). Consider the effective capacitance value carefully by consulting the manufacturer's data sheet.

Output Capacitor Selection

Choose the output bypass capacitance (C_{OUT}) to be 22µF. Larger values of C_{OUT} improve load transient performance, but increase the input surge currents during soft-start and output voltage changes. The output filter capacitor must have low enough ESR to meet output ripple and load transient requirements. The output capacitance must be high enough to absorb the inductor energy while transitioning from full-load to no load conditions. When using high-capacitance, low-ESR capacitors, the filter capacitor's ESR dominates the output voltage ripple in continuous conduction mode.

Therefore, the size of the output capacitor depends on the maximum ESR required to meet the output voltage ripple (V_{RIPPLE(P-P)}) specifications:

$$V_{RIPPLE(P-P)} = ESR \times I_{LOAD} \times LIR$$

where LIR is the inductor's ripple current to average current ratio. Compute LIR with Equation 1.

Equation 1:

$$LIR = \frac{V_{OUT} \times (V_{IN} - V_{OUT})}{V_{IN} \times f_{SW} \times I_{LOAD} \times L}$$

where I_{LOAD} is the buck's output current in the particular application (500mA max), V_{IN} is the application's input voltage, and f_{SW} is 1MHz.

Ceramic capacitors with X5R or X7R dielectric are highly recommended due to their small size, low ESR, and small temperature coefficients. All ceramic capacitors derate with DC bias voltage (effective capacitance goes down as DC bias goes up). Generally, small case size capacitors derate heavily compared to larger case sizes (0603 case size performs better than 0402). Consider the effective capacitance value carefully by consulting the manufacturer's data sheet.

Inductor Selection

Choose an inductor with a saturation current that is greater than or equal to the the maximum peak current limit setting ($I_{LX-PEAK}$). Inductors with lower saturation current and higher DCR ratings are physically small. Higher values of DCR reduce buck efficiency. Choose the RMS current rating of the inductor (the current at which the temperature rises appreciably) based on the system's expected load current.

Choose an inductor value based on the $V_{\mbox{OUT}}$ setting. See Table 3.

The chosen inductor value should ensure that the peak inductor ripple current (I_{PEAK}) is below the high-side MOSFET peak current limit ($I_{LX-PEAK}$) so that the buck can maintain regulation.

Table 3. Inductor Value vs. Output Voltage

V _{OUT} RANGE	MINIMUM INDUCTOR VALUE (μH)
V _{OUT} ≤ 5V	10
5V < V _{OUT} ≤ 7.5V	15
7.5V < V _{OUT} ≤ 11V	22
11V < V _{OUT} ≤ 17V	33
V _{OUT} > 17V	47

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Use Equation 2 and Equation 3 to compute I_{PEAK}. If I_{PEAK} is greater than I_{LX-PEAK} then increase the inductor value. For V_{OUT} \leq 5V, a 10µH inductor is suitable across the entire input voltage range for 500mA maximum DC load.

Equation 2:

 $I_{P-P} = \frac{V_{OUT} \times (V_{IN} - V_{OUT})}{V_{IN} \times f_{SW} \times L}$ Equation 3:

$$I_{\text{PEAK}} = I_{\text{LOAD}} + \frac{I_{\text{P}-\text{P}}}{2}$$

where I_{LOAD} is the buck's output current in the particular application (500mA max), V_{IN} is the application's largest expected input voltage (24V max), and f_{SW} is 1MHz.

Limiting the Peak Inrush Current

The peak inrush current from IN1 or IN2 to SUP must be limited to less than 4.1A. This can be achieved by reducing the slew rate of the input voltage applied to IN1 or IN2, and/or reducing the value of the SUP capacitor. The peak inrush current through the input power MUX when voltage is applied to IN1 or IN2 is calculated with Equation 4.

Equation 4:

$$I_{\text{INRUSH}} = C_{\text{SUP}} \frac{dV_{\text{IN}}}{dt}$$

where I_{INRUSH} is the peak inrush current, C_{SUP} is the SUP capacitance value, and dV_{IN}/dt is the slew rate of the input voltage on IN1 or IN2. For example, given the following conditions, the peak input current (I_{INRUSH}) upon voltage application is 500mA:

Given:

- C_{SUP} = 1µF
- $dV_{IN}/dt = 500 mV/\mu s$

Calculation:

•
$$I_{INRUSH} = 1\mu F \frac{500mV}{\mu s}$$

• I_{INRUSH} = 500mA

It is not recommended to "hot insert" the input with a precharged voltage source. The voltage slew rate of a hot insertion is very fast and can cause inrush currents in excess of 4.1A.

Setting the Output Voltage (MAX77756D)

The external feedback version of the device (MAX77756D) uses resistors to set the output voltage between 1V and 99% of the input voltage. Connect a resistor divider between V_{OUT}, OUT/FB, and AGND as shown in Figure 11. Choose R_{BOT} (OUT/FB to AGND) to be less than or equal to 100k Ω . Calculate the value of R_{TOP} (V_{OUT} to OUT/FB) for a desired output voltage with Equation 5.

Equation 5:

$$R_{\text{TOP}} = R_{\text{BOT}} \times \left[\frac{V_{\text{OUT}}}{V_{\text{FB}}} - 1\right]$$

where V_{FB} is 1V and V_{OUT} is the desired output voltage.

For the internal feedback versions (MAX77756A/ MAX77756B/MAX77756C) change the bits in V_ OUTREG[7:0] to program the output voltage between 1V and 7.5V in 50mV steps per LSB.

Figure 11. External Feedback Resistors

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PCB Layout Guidelines

Careful circuit board layout is critical to achieve lowswitching power losses and clean, stable operation. Figure 12 shows a sketch of an example PCB top-metal layout.

When designing the PCB, follow these guidelines:

- The SUP capacitor should be placed immediately next to the SUP pin of the device. Since the device operates at 1MHz switching frequency, this placement is critical for effective decoupling of high-frequency noise from the SUP pin.
- 2) Similarly, the input capacitors (C_{IN1}/C_{IN2}) should be placed immediately next to their respective input pins.
- 3) Place the inductor and output capacitor close to the part and keep the loop area small.
- 4) Make the trace between LX and the inductor short and wide. Do not to take up an excessive amount of area. The voltage on this node is switching very quickly and additional area creates more radiated emissions.
- 5) Connect PGND and AGND together at the return terminal of the output capacitor. Do not connect them anywhere else.
- 6) Keep the power traces and load connections short and wide. This practice is essential for high efficiency.
- 7) Place the BIAS capacitor ground next to the AGND pin and connect with a short and wide trace.

Figure 12. PCB Top-Metal and Component Layout Example

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Powering USB Type-C Power Delivery Port Controllers

The MAX77756 is ideal for battery-powered systems/ gadgets that use USB type-C with power delivery (PD) to charge. These systems require a PD port controller to monitor device attachment to the USB port, determine roles of the attached device, and negotiate for PD voltages. See <u>Figure 13</u>. Applications that use the MAX77756 to power the PD controller benefit in the following ways:

- Dual-input power MUX allows the device to power from VBUS or BATT ensuring the load is always powered. This enables PD negotiation even if the gadget battery is dead.
- Low I_Q consumption (19µA typ for dual-input) enables the device to remain always-on. This extends battery life and functionality by enabling the PD port controller to monitor plug attachment while the gadget is in sleep/hibernate state.
- 3V-24V input voltage range allows the device to power the port controller over the entire PD voltage range.
- Hardware or software enable allows flexible control from a host processor.

For more information on USB type-C PD, refer to the USB website and specification documents that are readily available and free on the internet.

Figure 13. USB Type-C PD Port Controller Power Supply

24V Input, 500mA Buck Regulator with Dual-Input Power MUX

Backup Power for Always-On Clocks and Sensors

The MAX77756's integrated dual-input power MUX is ideal for providing backup power to critical always-on circuits such as motion sensors, light curtains, and real-time clocks (RTCs). See <u>Figure 14</u>. If primary power is suddenly removed, the buck input seamlessly transitions to backup power. V_{OUT} is nearly unaffected by the transition. See Figure 15.

Figure 14. Uninterruptible Power Supply for Always-On Circuit

Figure 15. Switchover to Backup Power after Sudden Unplug

Creating an Instant-On System

The MAX77756 can be used to implement an instant-on battery charging system. See Figure 16.

- The battery charger (MAX8971 or similar) charges the cell from USB power.
- The dual-input power MUX selects the higher-voltage (USB) to power the buck.
- USB continues to power the buck even after the battery is finished charging.
- The the device switches over to BATT power when USB disconnects.

Select a battery charger with automatic input-current limiting (AICL) or minimum input-voltage regulation. The MAX8971 switch-mode charger with AICL regulates a minimum input (USB) voltage by reducing the charge current into the cell. This preserves a stable USB source for the device while charging the battery with residual power not used by the load.

This system can be extended beyond a single Li+ cell in USB type-C power delivery applications.

Figure 16. Simple Instant-On Battery System

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Typical Application Circuits

I²C Control, Dual-Input, Internal Voltage Feedback

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Typical Application Circuits (continued)

EN Pin Control, Single-Input (Power MUX Bypassed), Internal Voltage Feedback

EN Pin Control, Dual-Input, External Voltage Feedback

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Ordering Information

PART	VOLTAGE FEEDBACK	OUTPUT VOLTAGE (V _{OUT-REG})
MAX77756AEWL+	Internal	1.8V
MAX77756BEWL+	Internal	3.3V
MAX77756CEWL+	Internal	5.0V
MAX77756DEWL+	External	N/A (set by feedback resistors)

+Denotes a lead(Pb)-free/RoHS-compliant package.

T = Tape and reel.

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Revision History

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
0	4/17	Initial release	
1	10/17	Updated <i>Benefits and Features</i> , added Note 3, updated Figure 9, updated <i>Inductor Selection</i> section and added Table 3, replaced Figure 12, added three new sections with application diagrams to <i>Applications Information</i> section, replaced <i>Typical Application Circuits</i>	

For pricing, delivery, and ordering information, please contact Maxim Direct at 1-888-629-4642, or visit Maxim Integrated's website at www.maximintegrated.com.

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